1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection encapsulated in a small SOD123 Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Forward current: I_F ≤ 1 A
- Reverse voltage: V_R ≤ 30 V
- Low forward voltage typ. V_F = 450 mV
- Low reverse current typ. I_R = 40 μA
- Small SMD plastic package
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · Low voltage rectification
- · High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Reverse polarity protection
- Low power consumption applications
- Automotive applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
IF	forward current	$T_{sp} \le 55 ^{\circ}C$		-	-	1	Α
V_R	reverse voltage	T _j = 25 °C		-	-	30	V
V _F	forward voltage	I_F = 1 A; $t_p \le 300$ μs; $δ$ = 0.02; T_j = 25 °C		-	450	560	mV
I_{R}	reverse current	$V_R = 30 \text{ V}$; pulsed; $T_j = 25 \text{ °C}$	[1]	-	40	150	μA

^[1] Very short test pulse to prevent junction self-heating.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	1 2	К _[
2	А	anode	SOD123	sym001

[1] The marking bar indicates the cathode.



6. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
PMEG3010EGW-Q	SOD123	plastic, surface-mounted package; 2 leads; 2.675 mm x 1.6 mm x 1.15 mm body	SOD123				

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG3010EGW-Q	GD

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	30	V
l _F	forward current	T _{sp} ≤ 55 °C		-	1	Α
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 70 °C	[1]	-	1	А
		δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 135 °C		-	1	А
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ ms}; \delta \le 0.25$		-	7	A
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	9	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	400	mW
			[1]	-	660	mW
T _j	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

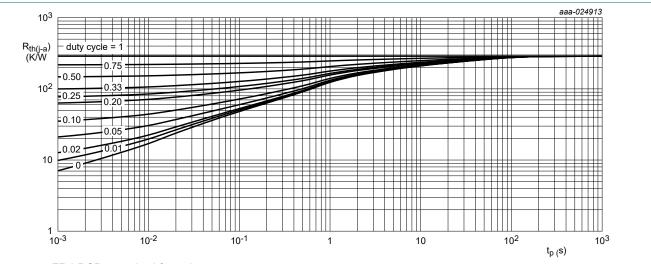
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

9. Thermal characteristics

Table 6. Thermal characteristics

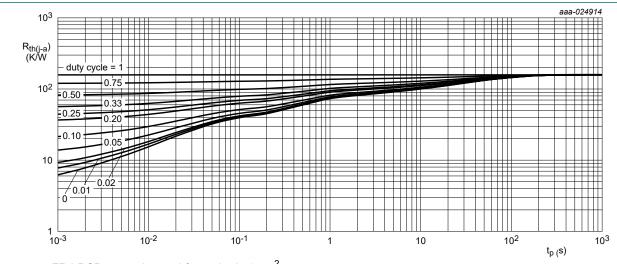
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	310	K/W
junction to amb	junction to ambient		[1] [3]	-	-	190	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]	-	-	29	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I_R = 1 mA; $t_p \le 300$ μs; $\delta \le 0.02$; T_j = 25 °C		30	-	-	V
V _F	forward voltage	I_F = 0.1 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C		-	90	130	mV
		$I_F = 1 \text{ mA}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$		-	150	200	mV
		I_F = 10 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C		-	215	250	mV
		I_F = 100 mA; $t_p \le 300 \mu s$; $δ \le 0.02$; T_j = 25 °C		-	285	340	mV
		I_F = 500 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_j = 25 °C		-	380	430	mV
		I_F = 1 A; $t_p \le 300$ μs; $δ$ = 0.02; T_j = 25 °C		-	450	560	mV
l _R	reverse current	V_R = 10 V; pulsed; T_j = 25 °C	[1]	-	12	30	μΑ
		$V_R = 30 \text{ V}$; pulsed; $T_j = 25 ^{\circ}\text{C}$	[1]	-	40	150	μΑ
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C		-	55	70	pF

[1] Very short test pulse to prevent junction self-heating.

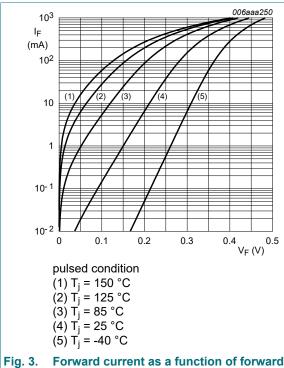


Fig. 3. Forward current as a function of forward voltage; typical values

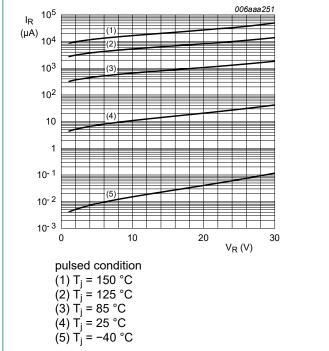


Fig. 4. Reverse current as a function of reverse voltage; typical values

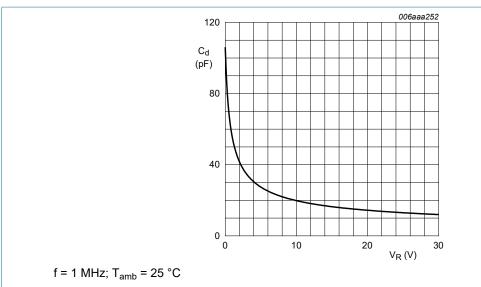
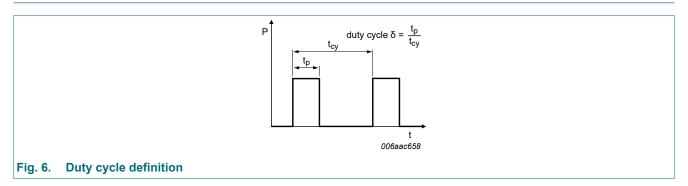


Fig. 5. Diode capacitance as a function of reverse voltage; typical values

11. Test information



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

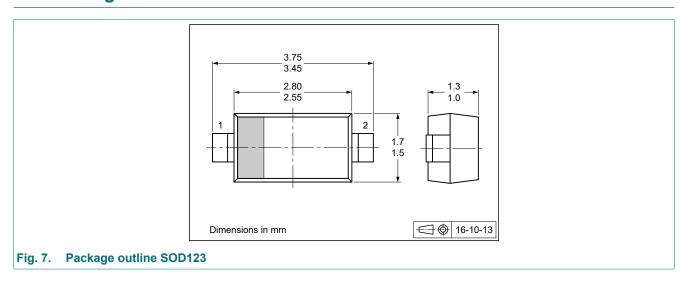
 $I_{RMS} = I_{F(AV)}$ at DC

 $I_{RMS} = I_{M} \times \sqrt{\delta}$ with I_{RMS} defined as RMS current

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering

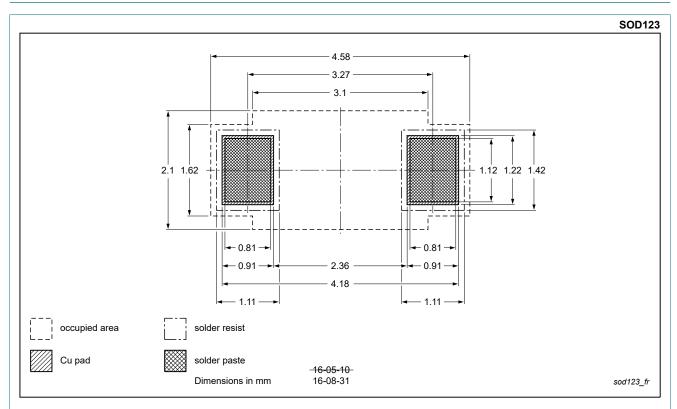


Fig. 8. Reflow soldering footprint for SOD123

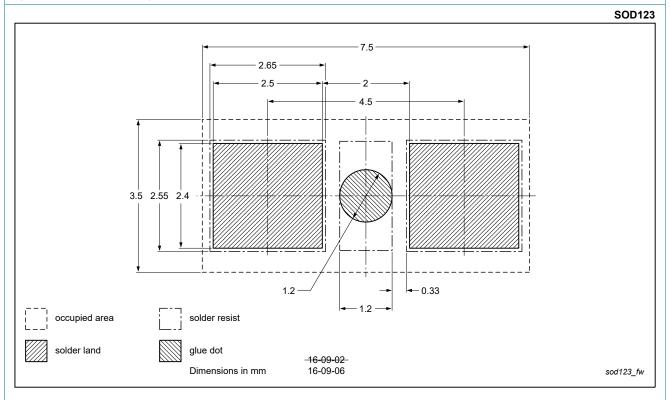


Fig. 9. Wave soldering footprint for SOD123

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG3010EGW-Q v.1	20220926	Product data sheet	-	-

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Product data sheet

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